

FIG. 1

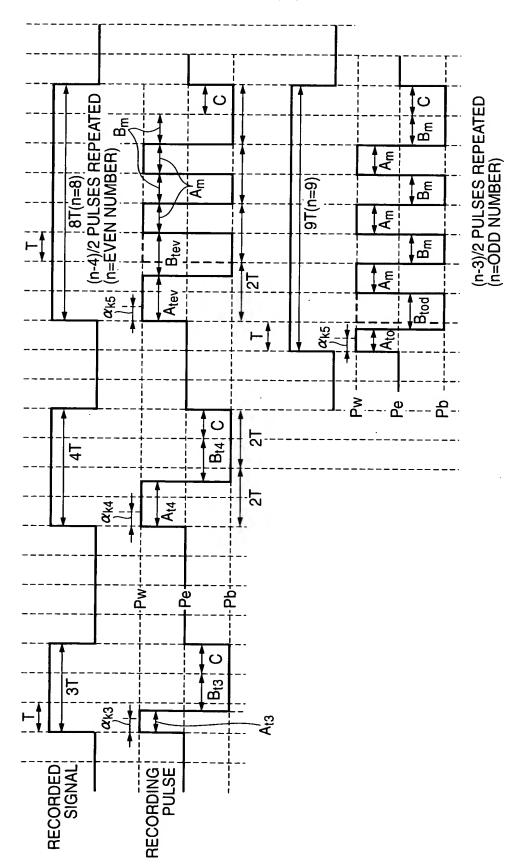


FIG. 2

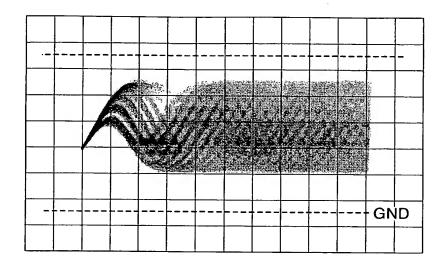


FIG. 3

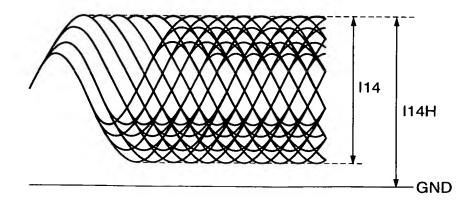


FIG. 4

		S S S	COMPOSITION OF RECORDING LAYER	9 1 1 1 1		MATERIAL OF REFLECTIVE LAYER		X4 SPEED JITTER MODULATION FACTOR TERION MODILI ATIONION	X6 SI MODUL IITTER/%)	X6 SPEED JITTER MODULATION FACTOR TEER (%) I MODULATION I ATTONION	X8 SP MODUL/	X8 SPEED JITTER MODULATION FACTOR TER/6/1 MODILI ATION/6/1	NOTES
10	Im	12	12	_	_1-	AgNdCu	8.3	MODULATION (%)	9.9	(%) NOTIFIED (%)	חוונה (%) –	MODULALION %	
0.779 0.95	IX)	+	0.03	3 -0.01	1	Ţ	8.2	73	1	1	1	ı	
0.832	<b>←</b>	+	-	+	+	<b>↓</b>	1	1	9.6	63	10.2	70	
EXAMPLE4   0.814   0	88	0.07	7 0.07	0.00	+	1	9.5	77	10.5	02	-	_	
0.824	0.91	<b>-</b>	0.05	0.05	5 1	1	9.6	74	10.4	<i>L</i> 9	-	-	
0.819	0.94	0.01	0.05	5 -0.04	4 Ag	<b>↓</b>	8.5	69	10.1	99	-	-	
_		<b>←</b>	-	-	i=	†	8.3	70	9.7	92	-	_	
_	<b>-</b>		+	+	Si	†	8.4	69	10.0	99	-	-	
-	<b>+</b>	+	1	1	Al	1	8.7	70	11.0	29	1	-	
-	-	+	+	1	Bi	1	9.1	70	10.5	64	1	ı	
	<b>←</b>	+	1	<b>+</b>	Ga	1	8.4	70	9.6	99		1	
0.817	0.93	0.02	+	-0.03	3 "X"	AgNdCu	8.4	72	9.6	29	1	1	
0.763	0.93	0.05	0.05	6  -0.03	3 "X"	AgPdCu	1	l	1	_	1	1	RECORDING FAILED
0.852	0.95	0.01	0.04	<b>←</b>	<b>←</b>	<b>+</b>	ì	55	1	20		-	MODULATED 60% OR LESS
0.794	0.97	0.01	0.05	-0.01	1	<b>←</b>	8.4	73	10.2	69	ı	- 1	ATTENUATED AT 80°C
0.815	0.81	0.12	0.07	0.05	<b>+</b>	<b>←</b>	14.7	78	20.4	9/	I	1	LOW REFLEC.
	←	0.07	0.12	-0.05	5 1	<b>←</b>	14.2	77	15.6	6/	ı	ı	LOW REFLEC.
0.830	0.88	0.09	0.03	90:00	3 1	<b>←</b>	14.1	92	19.8	72	ł	-	
0.800	0.00	0.05	0.08	-0.06	6 1	<b>↓</b>	13.2	75	13.3	69	-	1	
0.819 (	0.94	0.01	0.05	-0.04	4 Co	<b>+</b>	17.4	65	20.3	09	. 1	-	
0.817	0.93	0.02	<b>←</b>	-0.03	3 "X"	AI – Ti	12.2	63	14.9	58	1	ı	
	1												

FIG. 5

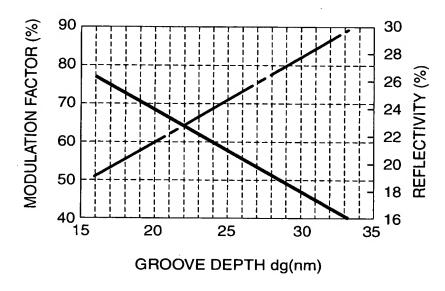


FIG. 6

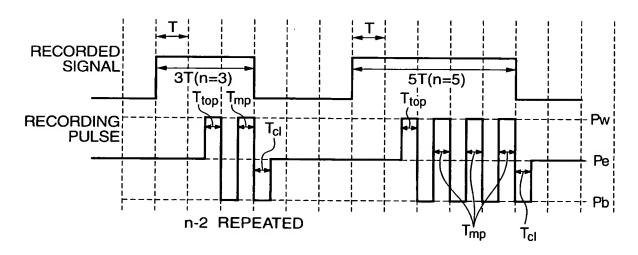


FIG. 7